



2814

PATENT
97-CC-240 DIVIN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
PHILIPPE GAYET, et al.)
Serial No.: 10/046,322)
Filed: October 23, 2001)
For: INTEGRATED CIRCUIT WITH)
STOP LAYER AND ASSOCIATED)
FABRICATION PROCESS)

Group Art Unit: 2814

Examiner: P. Cao

4/ Election
C. Stanley
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RESPONSE

Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated August 5, 2002, in connection with the above-identified application, please enter and consider the following remarks.

I hereby certify that this correspondence
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Dated